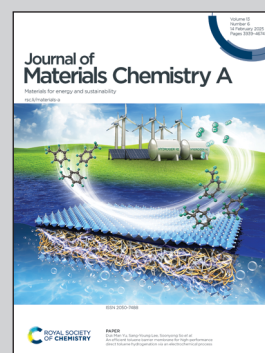


Led by Tomc, Dr. Bele, and Prof. Hodnik from the Laboratory of Electrocatalysis (ElectroCat) at the National Institute of Chemistry, Slovenia, in collaboration with leading Slovenian scientists, this study explores copper instability during electrochemical CO₂ reduction.

Deactivation of copper electrocatalysts during CO₂ reduction occurs *via* dissolution and selective redeposition mechanism

This research investigates copper's morphological restructuring mechanism during prolonged electrochemical CO₂ reduction, leading to gradual deactivation. It identifies dynamic dissolution-redeposition, mediated by reaction intermediates, as the key driver of declining catalyst performance. These findings guide strategies to improve copper's durability in industrial electrochemical CO₂ reduction.

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Deactivation of copper electrocatalysts during CO₂ reduction occurs *via* dissolution and selective redeposition mechanism†

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As electrochemical CO₂ reduction (ECR) nears industrialisation levels, addressing the uncontrolled stability, restructuring, and deactivation of copper (Cu) catalysts during operation becomes as crucial as achieving high activity and selectivity for a single product. This study used a high-surface area Cu catalyst that exhibited changes in ECR product selectivity over prolonged operation. The detection of dissolved Cu species during electrolysis confirmed an intermediates-mediated Cu dissolution mechanism at ECR potentials (−0.8 to −1.1 V vs. reversible hydrogen electrode). The findings suggest that the electrodeposition of dissolved Cu species is biased towards Cu catalyst sites with lower reaction intermediates coverage, e.g. adsorbed CO (*CO). A dynamic equilibrium between dissolution and subsequent selective redeposition gradually led to morphological restructuring, resulting in a shift in selectivity away from ECR and towards hydrogen production. With the obtained extensive experimental results, theoretical modelling, and literature data, four interconnected parameters governing restructuring and selectivity shifts were recognised: (i) size and (ii) crystallographic orientation of facets of the nanoparticles, (iii) *CO coverage and (iv) CO_{bridge} vs. CO_{atop} ratio.

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Introduction

The increasing concentration of CO₂ in Earth's atmosphere¹ has emerged as an urgent global concern due to its role in climate change and global warming. ECR on Cu has gained considerable attention as a means not only to reduce CO₂ emissions but also to produce valuable chemicals and fuels.^{2,3} For commercial applications, catalysts must exhibit high faradaic efficiency (FE)

and current density for a specific product, and, equally important, long-term operational stability.^{2,4} In recent years, substantial progress has been made in improving the activity and selectivity,^{5,6} however, numerous studies have highlighted the substantial morphological restructuring of Cu-based catalysts during operation.^{7–20} Since morphology is crucial for both the ECR activity and selectivity of Cu catalysts,^{14,15,21–24} a comprehension of this phenomenon is essential. Two distinct stages of morphological deformation can be identified during the ECR protocol: (i) catalyst immersion in the electrolyte without applied potential, later open circuit potential (OCP), followed by the application of the onset potential at the start of electrochemical measurement (initial stage of the ECR protocol) and (ii) electrochemical measurement, typically chronoamperometry (CA) at a constant ECR potential.

In the first stage, the dominant mechanism is dissolution–redeposition, driven by the formation of Cu-oxides on the catalyst surface at OCP.^{17–20} This degradation process unfolds in two steps: the dissolution of Cu-oxides at OCP, followed by dissolved species electrodeposition onto the catalyst surface when ECR potential is applied.^{17,18} Dissolved Cu species are in the Cu⁺ oxidation state,²⁵ and the electrodeposited Cu is low-coordinated.^{12,14,26,27} Raaijman *et al.*²⁰ demonstrated that this initial restructuring can be limited if the catalyst gets exposed to the electrolyte under applied potential. Undissolved Cu-oxides undergo reduction to metallic Cu at the initiation of CA,^{18,28–30}

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triggering transient dissolution followed by redeposition, leading to some unavoidable restructuring.¹⁹

Nevertheless, restructuring during the initial stage of the ECR protocol does not account for all Cu morphology changes, as alterations have been observed even during prolonged CA.^{7–15} Zhang *et al.*⁹ directly observed atomic restructuring of the Cu surface during ECR, noting the formation of a liquid-like amorphous structure at the interface between the Cu catalyst and the electrolyte, composed of Cu, O, H, and C. This process transformed an atomically smooth surface into a rough one. Moreover, their results indicated that Cu⁺ species exist at this interface. Vavra *et al.*,²⁵ using density functional theory (DFT) studies, demonstrated that soluble Cu species can exist at ECR potential in the form of [Cu⁺–ECR intermediates]_{XH₂O} complexes. Other studies also suggested that restructuring at ECR potential is facilitated by reaction intermediates, especially *CO.^{10,15,30,31} Alterations on Cu were observed even in a CO atmosphere.^{32,33} Therefore, it can be noted that intermediates-mediated dissolution initiates restructuring. Cu instability during the CA is of great importance as it impacts both activity and selectivity, usually leading to deactivation.^{7,15,34–43} Liu *et al.*⁷ suggested that the inactive Cu species formed through this process contain *CO bound to two Cu atoms (CO_{bridge}) in contrast to the preferential *CO bound to a single Cu atom (CO_{atop}) at active sites. Other studies also proposed that CO_{bridge} is inactive,^{44,45} however, Chou *et al.*⁴³ elegantly showed that for the successful C–C coupling, a correct ratio of both forms is needed.

Although there have been significant efforts to limit instability^{6,34–38} and catalyst reactivation using pulsed techniques,^{7,40–42} deactivation remains an issue. To develop

industrially viable catalysts, stability must be prolonged by several orders of magnitude.⁴ Herein, this study reveals the fundamental mechanisms of Cu catalysts restructuring and deactivation through a dynamic equilibrium between Cu dissolution and selective redeposition, intending to provide the understanding and, consequently, design principles for optimizing operational conditions and/or stable catalysts to effectively address these currently uncontrollable alterations.

Results and discussion

Catalyst modification *via* dissolution–redeposition mechanism at the initial stage of ECR protocol

To address the challenge of dynamic restructuring during CA through dissolution–redeposition, the fundamentally similar dissolution–redeposition mechanism occurring at the initial stage of the ECR protocol was studied. Especially the electrodeposition of dissolved Cu occurred at similar conditions as during the reaction, however, in this first stage of the ECR protocol, its effect was more pronounced. Additionally, promising pulsed electrochemical techniques involve fluctuations between OCP (or near OCP) and ECR potential^{7,40–42,46–49} at which the Cu dissolution–redeposition mechanism is occurring.

A Cu-nanostructured catalyst on carbon support coated on a glassy carbon plate (GCp) was prepared (see Experimental section and Section S1 in ESI†). The catalyst's surface was primarily composed of Cu-oxides (Section S2†) and was therefore appropriate to observe the proposed dissolution–redeposition mechanism. Identical location scanning electron microscopy (IL-SEM) and inductively coupled plasma mass spectrometry (ICP-MS) were employed to track Cu movement

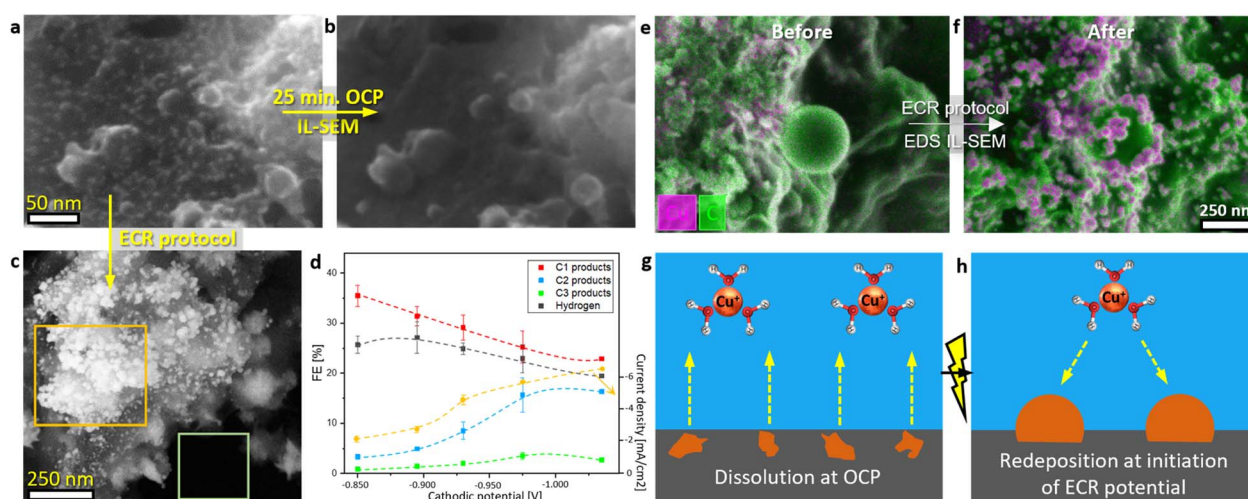


Fig. 1 (a and b) IL-SEM of the catalyst before and after OCP exposure in the CO₂-saturating 0.1 M KHCO₃ solution for 25 minutes. (c) SEM of the catalyst after the ECR protocol: 25 minutes at OCP, followed by the application of a constant -0.895 V vs. reversible hydrogen electrode (RHE) potential for 1 hour in the CO₂-saturating 0.1 M KHCO₃. The orange rectangle highlights a more exposed area where a greater number of particles formed that were larger in size, while the green rectangle indicates a submerged area where no nanoparticles were observed. (d) Catalyst ECR activity for various types of products and current density as a function of applied potential (detailed product analysis is provided in Section S3†). (e and f) Energy dispersive X-ray spectroscopy (EDS) mapping overlay in association with IL-SEM of the catalyst before and after ECR protocol: 25 minutes at OCP followed by the application of constant -0.975 V vs. RHE potential for 1 hour in the CO₂-saturating 0.1 M KHCO₃. Schematic representation of (g) Cu nanoparticles dissolution at OCP and (h) subsequent electrodeposition of dissolved Cu species upon applying ECR potential at the start of CA.



(Fig. 1a, b, e, f and S6g†). A rapid dissolution during the first minutes of OCP exposure, followed by a less pronounced dissolution (Fig. S6g† and results from ref. 18 and 25), indicate that Cu dissolution occurs in two stages: (i) an initial rapid dissolution of Cu-oxides up to a few 100 ppb, followed by (ii(1)) a slower process of Cu-oxides dissolution if there were any left after (i), or (ii(2)) an even slower process involving the oxidation of metallic Cu and subsequent dissolution of formed Cu-oxides if all oxides dissolved in the first minutes (Fig. S9†).

Upon applying the potential at the initiation of CA, the electrodeposition of dissolved Cu species resulted in the formation of spherical Cu nanoparticles, ranging from 5 to 80 nm in size, with a higher concentration of particles forming on more exposed surface areas (Fig. 1c, f and S12†). The dissolution–redeposition mechanism is schematically presented in Fig. 1g and h. In detail, the electrodeposition mechanism is presented in the following section (Cu electrodeposition *vs.* ECR). Through this dissolution–redeposition mechanism, the catalyst morphology was modified before the experiment. Several factors that influence Cu surface transformation were identified: (i) exposure of the catalyst to the electrolyte (Fig. 1c), (ii) amount of dissolved Cu (Fig. 3a and d), (iii) applied potential (Fig. 3a, b and ref. 29), (iv) *CO surface coverage (Fig. 3), (v) type of the catalyst used (comparing the effect of electrodeposition in Fig. 1c with IL-SEM results provided in ref. 17 and 50) and (vi) other experimental conditions.^{19,20} Since these factors are readily adjusted to optimise ECR, the exact effects of the process are difficult to predict. Therefore, it is important to determine catalyst modification at the initial stage of the ECR protocol for a better understanding of the processes occurring during the reaction. An effective approach to limit the phenomenon was applying the potential before introducing the electrolyte to the catalyst (Fig. S8c and d†), which triggered only the less intense transient dissolution and redeposition.

Considering pulsed electrochemical techniques, where the potential switches from OCP to ECR potential, the morphology of the catalyst could be directed in a specific way utilising the dissolution–redeposition mechanism at the initial stage of ECR protocol. It has been demonstrated previously that under ideal conditions, activity, selectivity, and, most importantly, long-term stability can be optimised.^{7,40–42,46–49}

The primary products of the ECR on the catalyst used in this study were formate and ethylene, with hydrogen evolution reaction (HER) accompanying the reaction (Fig. 1d and Section S3†). Aligning with the literature data,^{18,28–30,51} results in Section S2† also suggested that during operation Cu surface is in the Cu⁰ oxidation state. After air exposure, the metallic Cu surface oxidised to Cu₂O (Fig. S17†).

Restructuring and deactivation of the catalyst *via* dissolution during operation

During CA, the concentration of dissolved Cu was determined in the electrolyte using ICP-MS (Fig. S6g†). Catholyte was sampled at the 59th minute of CA at -0.975 V *vs.* RHE, while the ECR potential was still applied. A low concentration of Cu was

determined to be 11.8 ppb. Similarly, another sample was taken during a second ECR protocol, again at the 59th minute of CA measurement at -0.975 V *vs.* RHE. A lower concentration of dissolved Cu was determined (3.7 ppb). This observation aligns with a report by Zhang *et al.*⁹ where the Cu surface was observed to be dynamic at ECR conditions, forming an amorphous-like interface containing Cu between the electrolyte and the catalyst. Our results indicate that Cu can leach out of this layer through the proposed formation of [Cu⁺–ECR intermediates]_{XH₂O} complexes at ECR potential.²⁵

The catalyst used in this study experienced morphological restructuring during CA (Fig. 2c–e). The well-defined, smooth Cu nanoparticles formed through electrodeposition at the start of CA (Fig. 3a and b) did not change significantly until 2 hours (Fig. 2c). However, anisotropic restructuring of the nanoparticle surface was observed after 6 hours (Fig. 2d). Further nanoparticle restructuring occurred until 16 hours of CA (Fig. 2e). This process followed a mechanism opposite of Ostwald ripening, where smaller nanostructures grew through the dissolution of larger ones. A similar restructuring process was reported by Huang *et al.*,¹⁵ where smaller Cu nanoparticles formed from Cu nanocubes, similar in size to our nanoparticles. Since morphology changed during the reaction, selectivity alterations were expected.

Changes in product selectivity were monitored over the 16-hour CA (Fig. 2a). Formate production dropped from approximately 22% FE in the first hour to around 3% FE after 6 hours, before increasing back to around 5% FE. Ethylene formation increased from 6% to 10% FE and reached a plateau after 4 hours. At approximately 6 hours, its production started depleting as well. Other C₂₊ products experienced a similar trend. Conversely, a decrease in FE for HER occurred from the start, reaching a minimum before 4 hours. After that, HER FE increase was observed from 6 hours onwards. Methane production in the first hour barely increased and then exhibited a depleting trend. On the other hand, CO production remained constant throughout the 16-hour experiment. A repetition of the 16-hour experiment was conducted for gaseous products, yielding a similar trend (Fig. S28b†). By exchanging the electrolyte under potential control, therefore, preventing catalyst oxidation at OCP and subsequent dissolution–redeposition, the selectivity remained unchanged (Fig. 2a). This control experiment ruled out the potential effects of ECR products in the electrolyte, possible pH changes over 16 hours, and other factors on ECR.

Formate-producing sites deactivated more rapidly than C–C coupling sites (Fig. 2a). The initial increase in C₂₊ product formation during the first 4 hours could be attributed to the deactivation of formate-producing sites, which made more CO₂ available for *CO. We propose that the deactivation of C₂₊-producing sites began from the start but was initially masked by mass transport effects, leading to the observed activation. Similar could be observed for methane and CO. It could be noted that deactivation of methane-producing sites was faster than at C–C coupling sites but slower than at formate-producing sites. CO-producing sites showed the slowest deactivation, with a subsequent activation trend following the deactivation of C–C



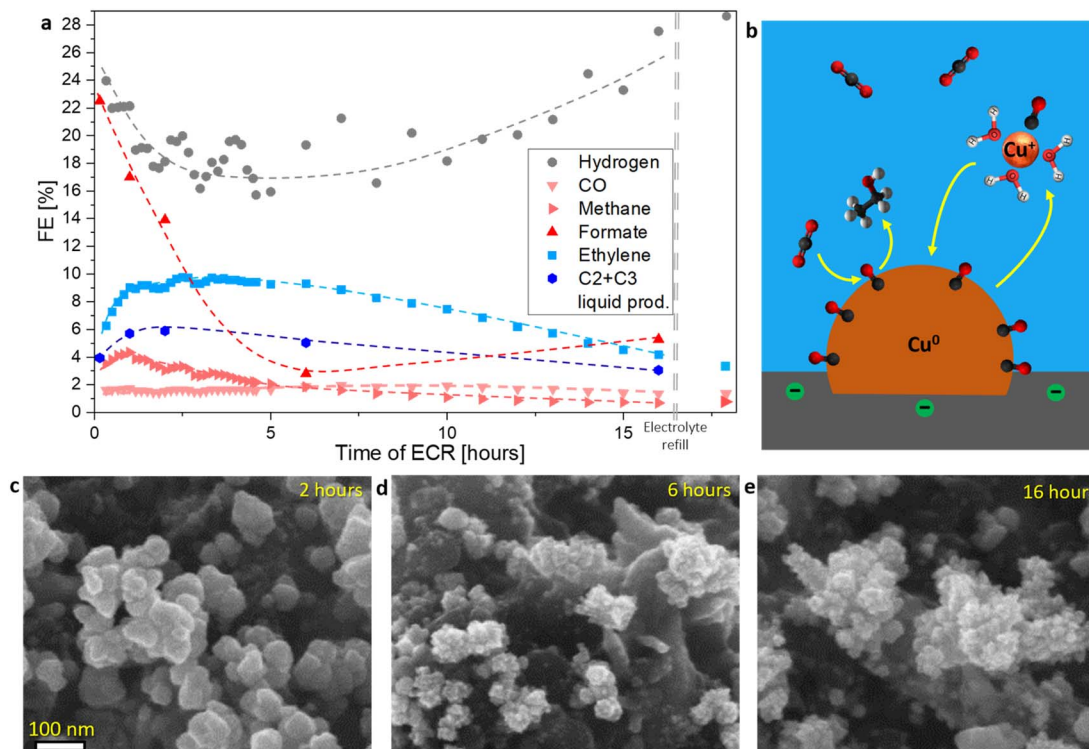


Fig. 2 (a) Analysis of ECR product selectivity over an 18-hour CA at a constant potential of -0.975 V vs. RHE in the CO_2 -saturating 0.1 M KHCO_3 . The double dashed line indicates the point at which the electrolyte was replaced with a fresh solution without interrupting the applied voltage. Liquid products were measured from five replicate samples after varying durations of electrolysis. Current density can be found in Fig. S28b.† (b) Schematic representation of catalyst restructuring through dissolution and redeposition during operation at ECR potential. (c–e) SEM images of three replicate samples illustrating the catalyst after varying durations of electrolysis.

coupling sites. A clearer CO site activation was observed at another catalyst, where the deactivation was more rapid (Fig. S28a†). The interconnections of different products were consistent with the established ECR mechanisms,² where for example by unsuccessful C–C coupling CO will form by desorbing from the Cu-surface, and if the formate reaction pathway is limited, CO_2 will reduce to methane, CO and C_{2+} products. The close interconnection between C–C coupling and HER-producing sites is evident in Fig. 2a, where an inverse relationship was observed: as selectivity for C–C coupling increased, HER selectivity decreased, and *vice versa*. In contrast, interconnection between formate and HER-producing sites was not observed. C–C coupling requires CO to remain on the Cu surface for an extended time, and C_{2+} products involve more than 8 electron transfers.² This results in a high population of C_{2+} intermediates on the Cu surface, consequently blocking HER. This is consistent with the report presented by Ooka *et al.*⁵²

Similar changes in FE for ECR products were reported by Huang *et al.*,¹⁵ though the different deactivation trends observed by other researchers suggest that further investigation is needed to fully understand the deactivation mechanisms for various ECR products. Particularly, the interconnections between different products are of interest and could, with additional data, offer a novel perspective on the ECR mechanism.

Cu electrodeposition vs. ECR

The observed so-called “anti-Ostwald ripening” nanoparticle evolution during CA (Fig. 2c–e and ref. 8, 14, 15) suggested that Cu growth at ECR conditions deviates from the typical ripening process, where curvature (Gibbs–Thomson effect) governs the enlargement of the larger particles at the cost of smaller ones. Consequently, the electrodeposition of dissolved Cu species at the initiation of CA was investigated. The process was, in principle, similar to during the reaction, only on a larger scale. IL-SEM images revealed that the electrodeposition and the ECR are competing processes (Fig. 3). This competition was first evident during the first ECR protocol, where nanoparticles formed at the potential with higher activity and selectivity for C–C coupling (-0.975 V vs. RHE; Fig. 1d) had a rougher surface compared to the surface of nanoparticles formed at a higher potential at which C–C coupling was less pronounced (Fig. 3a and b). Simon *et al.*²⁶ also reported the formation of rougher Cu surfaces with a higher density of undercoordinated Cu sites at lower potentials.

When the ECR protocol was repeated on the modified catalyst (second ECR; Fig. 3c–h), the dissolution during OCP was reduced due to the larger nanoparticles compared to the first ECR. After 40 minutes at OCP, most of the nanoparticles remained intact, resulting in a lower amount of dissolved Cu, compared to the first ECR protocol (Fig. S6e–g†). Consequently, when the onset potential of CA was applied, pre-existing Cu



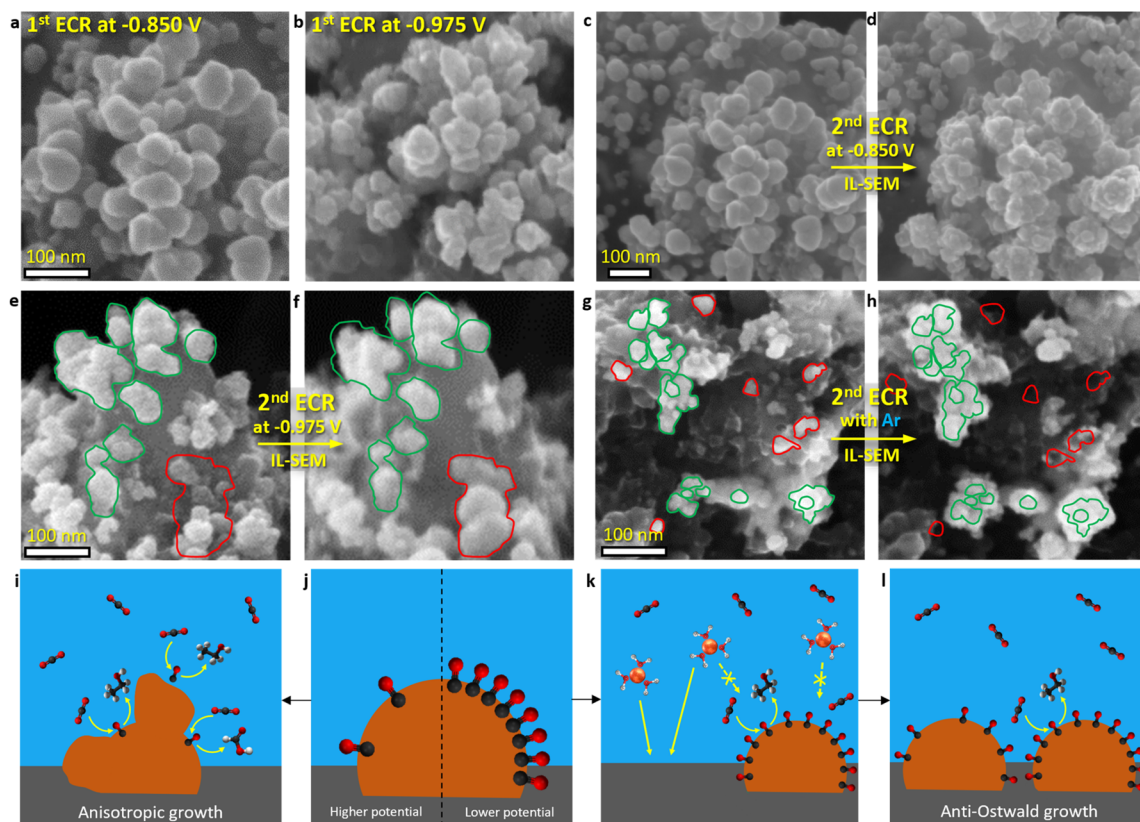


Fig. 3 SEM images of the catalyst after the ECR protocol: 25 minutes at OCP followed by the application of a constant (a) -0.850 V and (b) -0.975 V vs. RHE potential for 1 hour in the CO_2 -saturating 0.1 M KHCO_3 . IL-SEM images showing the catalyst before and after a repeated ECR protocol on catalysts from (a and b): (c and d) at -0.850 V vs. RHE and (e and f) -0.975 V vs. RHE. (g and h) IL-SEM of a repeated ECR protocol at -1.000 V vs. RHE with Ar-saturating electrolyte instead of CO_2 on a catalyst prepared at the same conditions as (b). (i and j) Schematic representation corresponding to (c and d), illustrating partial blocking of Cu electrodeposition by ECR. (j–l) Schematic representation corresponding to (e and f), showing complete blocking of Cu electrodeposition by ECR.

nanoparticles were already present on the catalyst surface, unlike in the first ECR. IL-SEM unveiled an even higher deviation from Ostwald ripening growth after electrodeposition at the onset potential of the second ECR. At -0.850 V vs. RHE, the surface of pre-existing nanoparticles roughened (Fig. 3c and d), similar to evolution during the reaction (Fig. 2c–e). However, when the modified catalyst was subjected to a second ECR protocol at the potential of -0.975 V vs. RHE (optimal for activity and selectivity for C–C coupling), the electrodeposition led to the formation of new nanoparticles alongside pre-existing ones (Fig. 3e and f). A potential of -0.895 V vs. RHE was sufficient to cause full surface obstruction on the catalyst used in this study (Fig. S34[†]). On the other hand, when the second ECR protocol was repeated with argon purging instead of CO_2 , Cu nanoparticles marked in green grew evenly at the cost of Cu nanoparticles marked in red (Fig. 3g and h). With CO_2 , expected ECR activity and selectivity were observed (Section S3[†]), while no products were detected with argon. Similar anisotropic growth of pre-existing nanoparticles was observed by Popović *et al.*^{17,50} using IL-SEM.

The electrodeposition of Cu was partially or fully blocked by ECR reaction intermediates, depending on the applied potential. A control experiment with argon purging ruled out any other parameters that could potentially interfere with

electrodeposition, *e.g.* electrolyte, and demonstrated how with classical electrodeposition of Cu, the curvature or size plays an important role, as also predicted by the Ostwald ripening phenomenon. As previously mentioned, $^*\text{CO}$ is the key ECR intermediate for successful C–C coupling. At the catalyst used in this study, this process was optimal at -0.975 V vs. RHE (Fig. 1d and Section 3[†]), where the greatest obstruction of Cu electrodeposition was observed (Fig. 3a–f). Gunathunge *et al.*^{31,44} found that the total amount of $^*\text{CO}$ on the Cu surface increases with decreasing potential, but it begins to decline after the optimal C–C coupling potential, a trend also noted by Zhan *et al.*⁵³ Similarly, Zhang *et al.*⁹ observed that the amorphous layer was the thickest at a potential optimal for C–C coupling. Furthermore, as shown in Fig. 1d and 2a, and by Ooka *et al.*,⁵² HER was most suppressed when C–C coupling was most favourable. Therefore, it can be concluded that more active C–C coupling sites create a greater obstruction for the electrodeposition of dissolved Cu species compared to less active ones, as schematically illustrated in Fig. 3i–l, consequently making the effect of nanoparticle curvature negligible.

This behaviour is not exclusive to Cu; similar phenomena have been observed in other metals where $^*\text{CO}$ acts as a capping agent to produce smaller nanoparticles, such as Pt⁵⁴ and Au.⁵⁵



Deactivation mechanism

The observations discussed above confirmed that Cu underwent restructuring and deactivation *via* a dynamic equilibrium between dissolution and redeposition, even at ECR potential. Previous studies have reported that *CO and other ECR intermediates facilitate Cu restructuring.^{10,15,25,30–33} Zhang *et al.*⁹ directly observed that dissolution occurred randomly, leaving behind a rough atomic surface, although the overall nanometer structure remained largely unchanged. The formation of small nanoparticles on top of pre-existing ones during CA on the catalyst used in this study (Fig. 2e and f) and the detection of Cu in the electrolyte (Fig. S6g†) demonstrated that Cu can leach out from the amorphous layer. As shown in Fig. 3, the electrodeposition of the dissolved Cu species was influenced by adsorbed ECR intermediates. These species preferentially electro-deposited onto sites with lower coverage of ECR intermediates, presumably the less ECR-active sites. This is because the highest *CO coverage typically coincides with the potential yielding the highest ratio of C₂₊ products *vs.* HER.^{31,53} Through multiple iterations of this process, these less active sites gradually grew at the expense of more active ones, consequently changing ECR selectivity, leading to deactivation and heightened HER production (Fig. 4a and b).

Given that the nanoparticles used in this study were similar in shape and size to those used by Reske *et al.*,²⁴ some correlations can be drawn. They demonstrated that spherical nanoparticles ranging from 0 to 15 nm on a GCp exhibited lower selectivity for ethylene and methane and higher for CO and HER than Cu foil. In this study, 28.5 nm (on average) spherical nanoparticles on GCp were prepared (Fig. S12b and c†). Product distribution (Fig. S26†) aligned nicely with the trends argued by Reske *et al.*²⁴ (Fig. 4c). Furthermore, the second ECR process, involving dissolution–redeposition at the initial stage of the ECR protocol, yielded larger nanoparticles than the first ECR (Fig. S16†). These larger nanoparticles had an increased selectivity for C₂₊ products and reduced selectivity for HER (Section S3†). The most prominent effect was observed at a potential optimal for ECR, -0.975 V *vs.* RHE, where through anti-Ostwald growth relatively large nanoparticles grew (Fig. 3e and f). The trends therefore suggested that smaller spherical nanoparticles are less active for ECR, indicating that restructuring into smaller particles may have contributed to the observed deactivation (Fig. 2a). Considering the Cu electrodeposition, these sites were less active for ECR and more active for HER, therefore less covered by reaction intermediates and were consequently more pronounced to grow through electrodeposition. Reske *et al.*²⁴ have nicely demonstrated how with lowering particle size, the coordination number of surface Cu atoms decreases.

However, with Ar instead of CO₂ in the second ECR Ostwald nanoparticle growth was observed (Fig. 3g and h), therefore the nanoparticles got bigger, which by this hypothesis would mean a heightened selectivity for ECR. When the selectivity and activity were measured a heightened HER *vs.* ethylene production was observed compared to the first ECR (Fig. S27†). Similarly to this study, the formation of smaller nanostructures during CA has been reported previously,^{7,8,14,15} although the

impact on ECR selectivity varies across these studies. Liu *et al.*⁷ and Huang *et al.*¹⁵ observed a deactivation trend, while Grosse *et al.*¹⁴ reported no significant changes in selectivity. Moreover, Jung *et al.*⁸ demonstrated that 20 nm cubic particles gradually fragmented into 2–4 nm particles under negative potential, leading to enhanced C–C coupling at the expense of HER. Therefore, the formation of smaller nanoparticles that cause ECR deactivation is not a general trend, meaning that more parameters govern the alterations.

Liu *et al.*⁷ observed that during deactivation, nanostructures preferentially formed with (111) facets from the original (100). In contrast, Kim *et al.*¹¹ reported the formation of (100) facets during prolonged ECR operation. To understand the discrepancies between these two findings, DFT modelling of *CO bound in bridge and atop configurations (Fig. 4h) on (100) and (111) Cu facets (Fig. 4d and e) was conducted (Section S6†). The calculations were performed using a Solvated Jellium Model⁵⁶ (SJM) at default parameters and a potential of -1.0 V *vs.* RHE. Supercells with 36 surface Cu atoms and one water molecule replaced with *CO were used to imitate the real systems where total *CO coverage is around 0.05.⁵⁷ The CO_{binding} energies at (111) *vs.* (100) facets showed a slight variation, suggesting that at ECR potential total *CO coverage is different between the crystallographic orientation of facets (Fig. 4f). Since the results in Fig. 3 suggested that different *CO coverages result in different surface obstructions for Cu electrodeposition, and literature data demonstrated different ECR selectivity on different facets,^{22,23} it can be concluded that different Cu facets are of great importance for the restructuring. The difference in CO_{binding} energies at Cu (111) *vs.* (100) indicates that through dissolution–redeposition at ECR potential, (111) facets will start predominating over (100), which aligns with the observations by Liu *et al.*⁷ In the report a total *CO coverage also changed with time, suggesting the correctness of the explanation. However, different ECR parameters (potential, pH, electrolyte, *etc.*) could significantly influence the small energy gap between *CO bound at different facets and therefore the resulting formation of specific Cu sites.

Liu *et al.*⁷ also observed that during deactivation, CO_{bridge} began to prevail over CO_{atop}. Similarly, another study reported that deactivation was accompanied by the formation of CO_{bridge} and loss of CO_{atop}.⁴³ Theoretical data indicated that it is thermodynamically more favourable for CO to adsorb on the surface as a bridge than atop at (111), while on (100) the energy difference between the two *CO forms is not as distinct (Fig. 4g). The observed formation of CO_{bridge} during operation could thus be related to the energy released as CO_{atop} gradually transitions to CO_{bridge}. Especially the report by Liu *et al.*,⁷ where (100) sites reformed to (111) and CO_{bridge} started prevailing over CO_{atop}, could be explained by the results from this study. It has been reported previously that if CO_{bridge} is the dominant *CO surface species on Cu, C–C coupling is hindered.^{43–45} Therefore, the gradual formation of CO_{bridge} during CA could be a key factor contributing to the deactivation, as Liu *et al.*⁷ have argued.

Data from the literature and this study suggested some trends in alterations during ECR, though with currently limited data a general behaviour remains elusive. Anisotropic



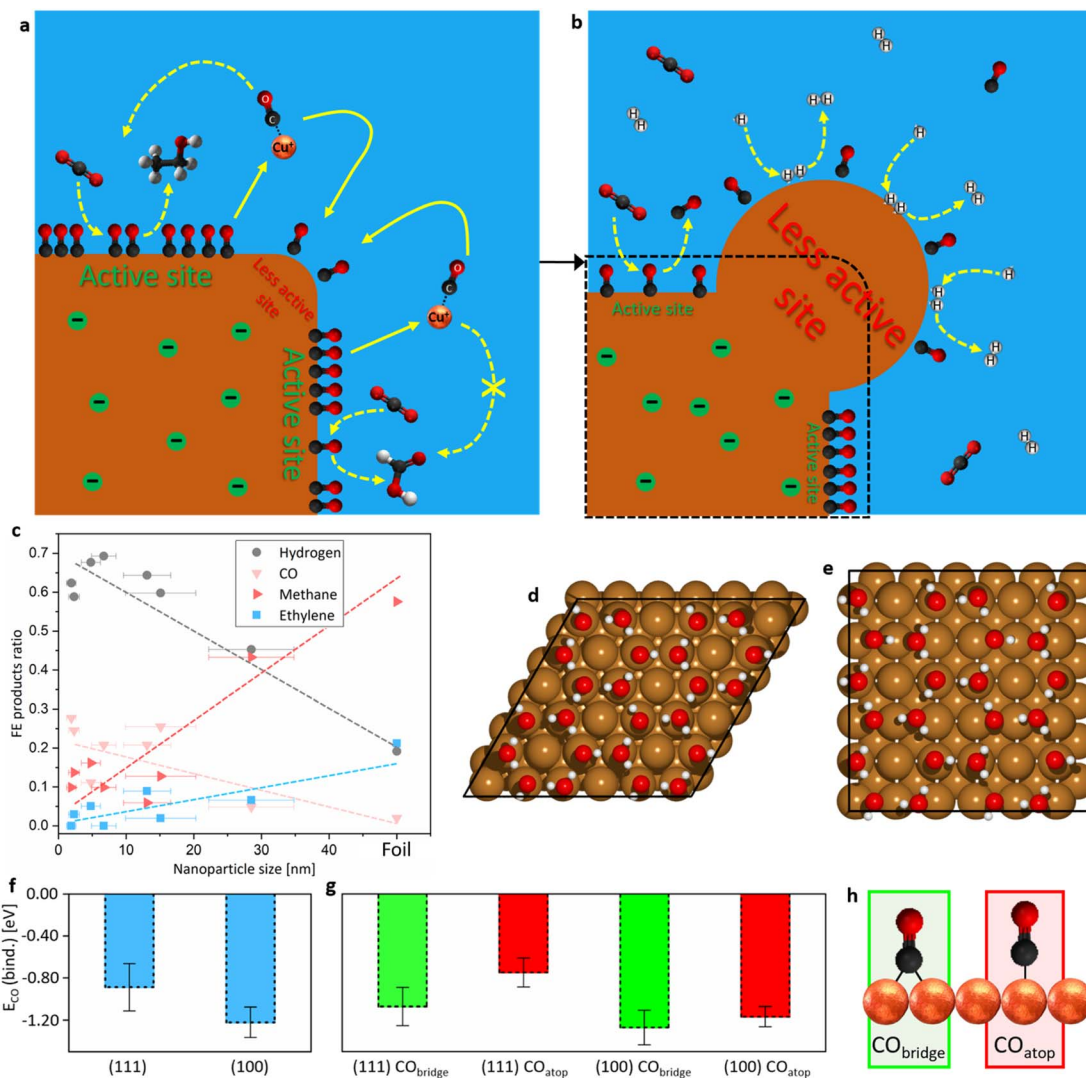


Fig. 4 (a) Proposed mechanism depicting dynamic selective dissolution–redeposition of Cu restructuring during CA at a catalyst used in this study, leading to (b) the formation of hydrogen-producing sites. The shapes of Cu sites are only representative. (c) Graph of different products FE vs. nanoparticle size adapted from Reske *et al.*²⁴ The results from this study are 28.5 nm spherical nanoparticles on GCp (Fig. S12b, c and S13†). (d) Cu (111) and (e) Cu (100) supercells with explicit water layer used in DFT calculations. For the results presented in (f and g) one water molecule was removed at different positions and then CO was placed into the vacancy at different Cu atoms in bridge or atop positions as presented in Fig. S39.† CO_{binding} energies were calculated as demonstrated in Section S6† at an applied potential of -1.0 V vs. RHE. (f) An average of all calculated CO_{binding} energies (Fig. S40†) at (111) vs. (100) Cu-facets. (g) An average of all calculated CO_{binding} energies with *CO bound as bridge vs. top at (111) vs. (100) Cu-facets. The scale of (f) applies to (g) as well. (h) Representation of *CO bound to Cu surface as bridge and atop configurations.

morphological restructuring occurred forming smaller nanoparticles, however, it was shown that ECR selectivity changes could be beneficial with this process. The dominance of CO_{bridge} over CO_{atop} was linked to the deactivation of C–C coupling, though the total amount of *CO, crucial for ECR, also changed. The significant influence of different Cu surfaces on ECR selectivity is evident, yet reports vary as some indicate the formation of (111) facets during operation, while others show a reformation to (100). There are numerous interconnections between these features, and it is possible that additional factors influence ECR selectivity changes, *e.g.* the applied potential, electrolyte (type and its concentration), cell design (distances, volume), flows (gas and electrolyte), *etc.* The uncontrolled

stability, restructuring, and deactivation of Cu catalysts during operation therefore result from a complex interplay of various parameters. To fully understand and mitigate the effects of the dissolution–redeposition mechanism during CA, further research is needed. This should involve studies on different Cu single crystals and nanoparticles, focusing on the dissolution of Cu, changes in morphology, and alterations in adsorbed CO bands, along with the impact on the catalyst's ability to reduce CO_2 . Additionally, DFT calculations could be beneficial to comprehend the effects.

Before concluding, one final comprehension considering pulsed techniques can be made based on the results from this study, which may help the researchers in this field. The effect of



dissolution–redeposition yielded the highest selectivity for C_{2+} products at an electrodeposition potential of -0.975 V vs. RHE in a CO_2 -saturated electrolyte with minimal air exposure during OCP (Fig. S27[†]), therefore utilizing the dissolution through the slow process of oxidation–dissolution, rather than air exposure, formation of Cu-oxide shells, and rapid dissolution at OCP. Moreover, the dissolution–redeposition in Ar resulted in the formation of sites unfavourable for ECR.

Conclusions

This study delves into the mechanism of the observed dynamic restructuring of Cu-based catalysts at ECR conditions, highlighting a significant challenge in developing stable, industrially viable electrocatalysts. Given that stability must be enhanced by three orders of magnitude, understanding the changes occurring during operation is crucial. Alterations in Cu surface morphology and ECR selectivity were observed during CA, with the detection of dissolved Cu species suggesting the formation of $[Cu^+-ECR\text{ intermediates}]_{xH_2O}$ complexes under these conditions. The ECR was found to compete with the electrodeposition of dissolved Cu, leading to atypical Cu nanoparticle growth. The dynamic equilibrium of the dissolution–redeposition mechanism at ECR potential facilitated Cu movement to the less active sites and catalyst deactivation. Alongside literature data, this study identified a complex interplay of four key parameters affecting ECR selectivity: nanoparticle size, the crystallographic orientation of facets, $*CO$ surface coverage, and the CO_{bridge}/CO_{atop} ratio. Further investigations are needed to elucidate the important steps in FE alterations of different Cu catalysts, which usually experience changes at different rates. While the mechanism is somewhat clear, its impact on different catalysts remains uncertain. The observed restructuring phenomena for other metals indicate broader implications of this knowledge beyond Cu.^{9,36,58,59}

We anticipate that our findings and methodologies will inform future endeavours aimed at designing stable Cu catalysts capable of effectively closing humanity's CO_2 cycle. In conclusion, we echo the sentiment encapsulated in the following quote summarising this work: “*Copper's most powerful tool for fighting global warming is also its greatest weakness.*”

Data availability

All other data related to the research content of this paper are provided in the ESI.[†] The authors have cited additional references within the ESI.^{†60–82}

Author contributions

Blaž Tomc: conceptualisation, data curation, investigation, methodology, visualisation, writing – original draft. Marjan Bele: conceptualisation, investigation, methodology, supervision. Mohammed Azeezulla Nazrulla: conceptualisation, investigation, methodology. Primož Šket, Angelja Kjara Surca, Ana Rebeka Kamšek, Martin Šala, Jan Šiler Hudoklin, Matej Huš: data curation, investigation, methodology. Matjaž Finšgar: data

curation, investigation, methodology, writing – review & editing, funding acquisition. Blaž Likozar: supervision, funding acquisition. Nejc Hodnik: conceptualisation, funding acquisition, project administration, supervision, validation, writing – review & editing.

Conflicts of interest

There are no conflicts to declare.

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